

Fig. 1

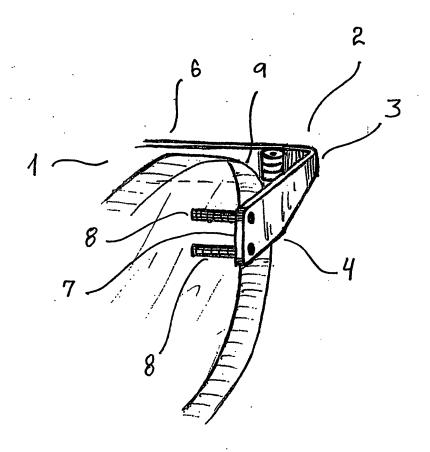


Fig. 2



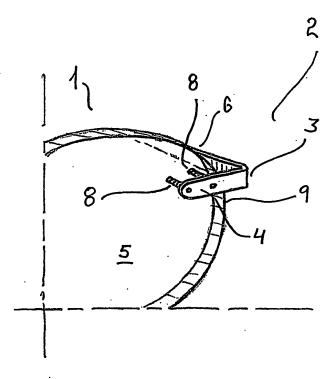


Fig. 3A

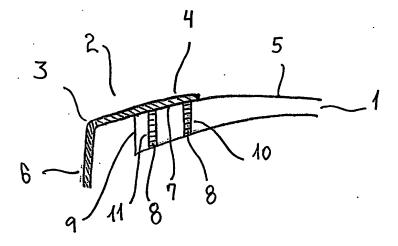
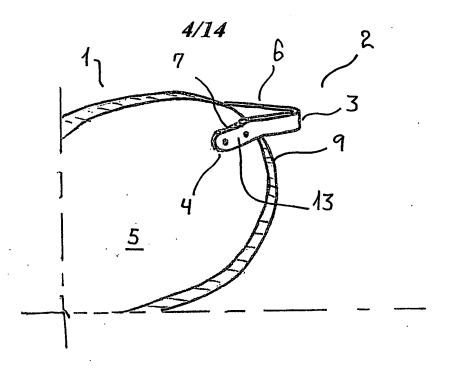
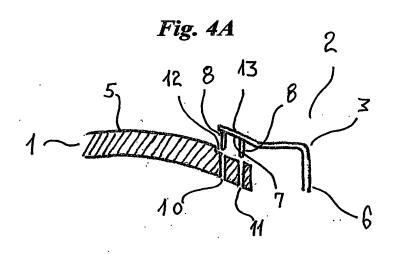


Fig. 3B

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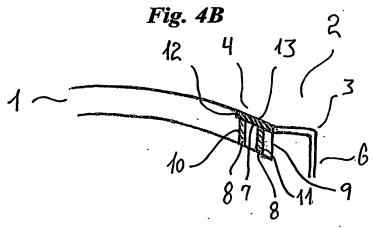


Fig. 4C

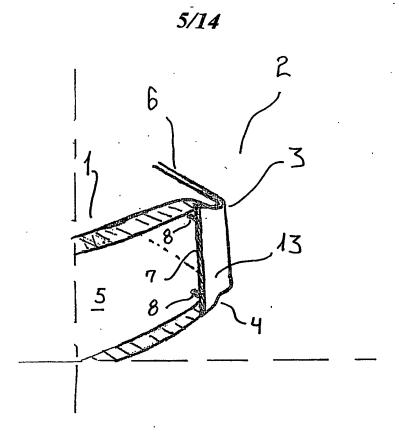


Fig. 5A

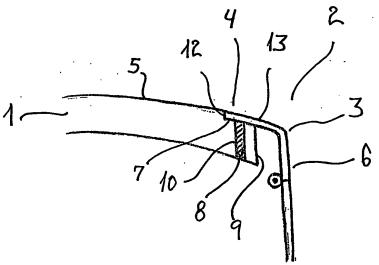


Fig. 5B

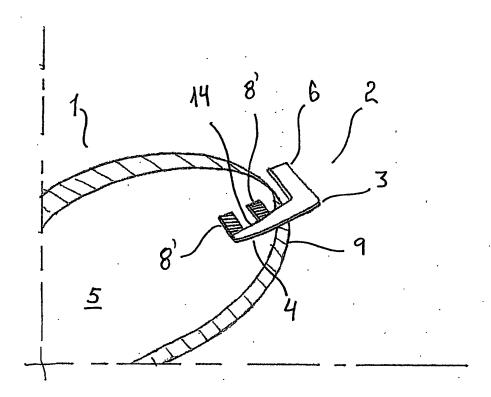


Fig. 6

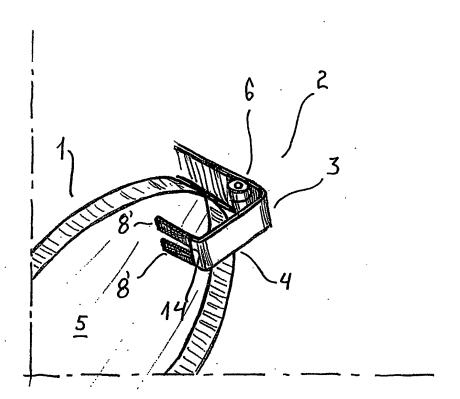


Fig. 7

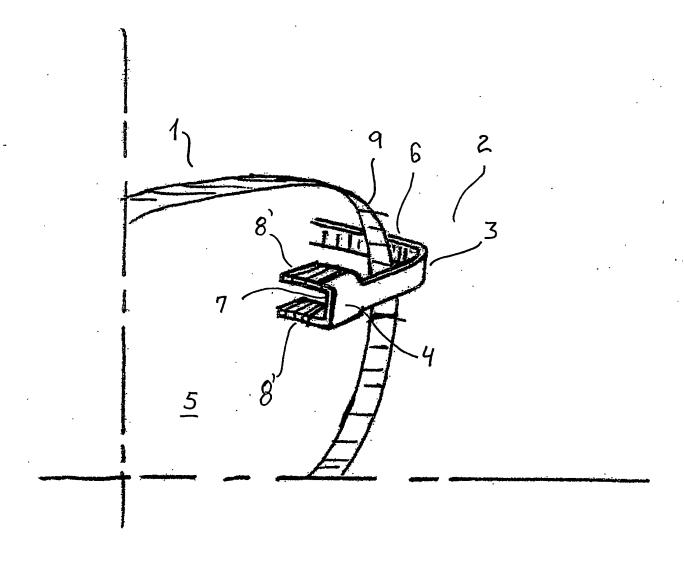


Fig. 8

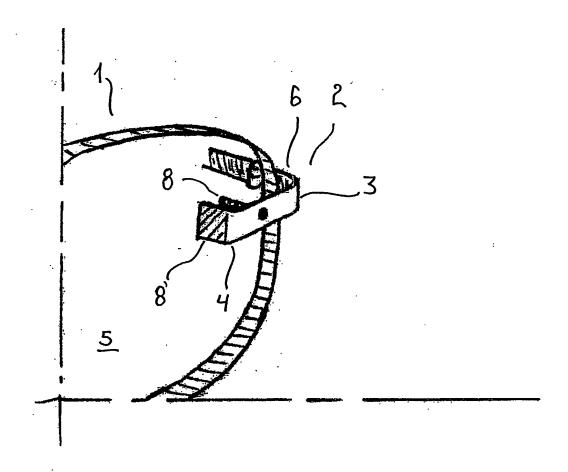


Fig. 9

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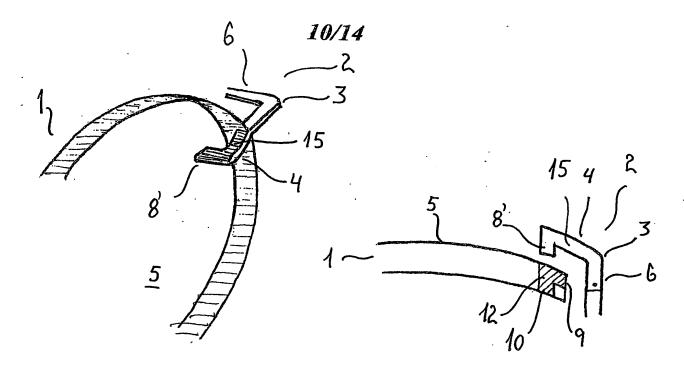


Fig. 10 A

Fig. 10 B

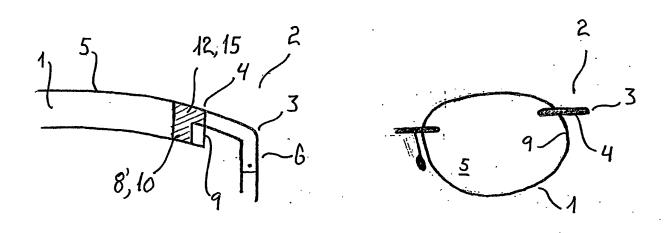
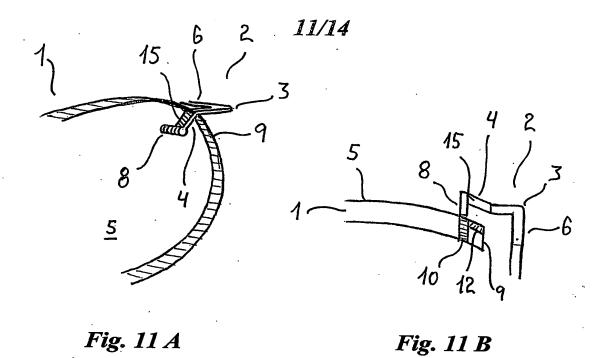
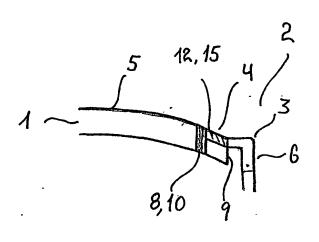


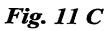
Fig. 10 C

Fig. 10 D

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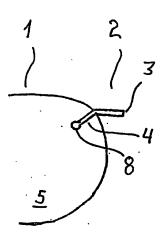


Fig. 11 D

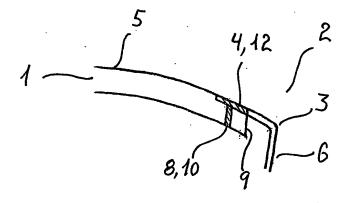


Fig. 12 A

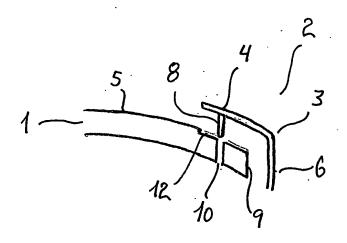


Fig. 12 B

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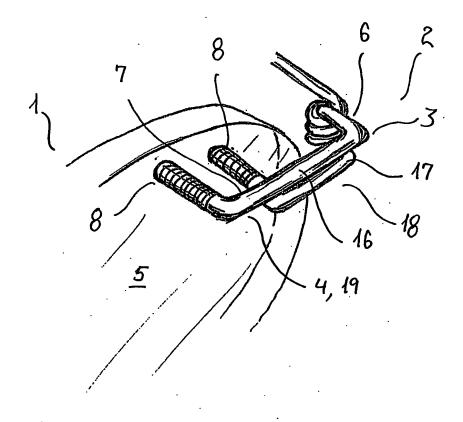
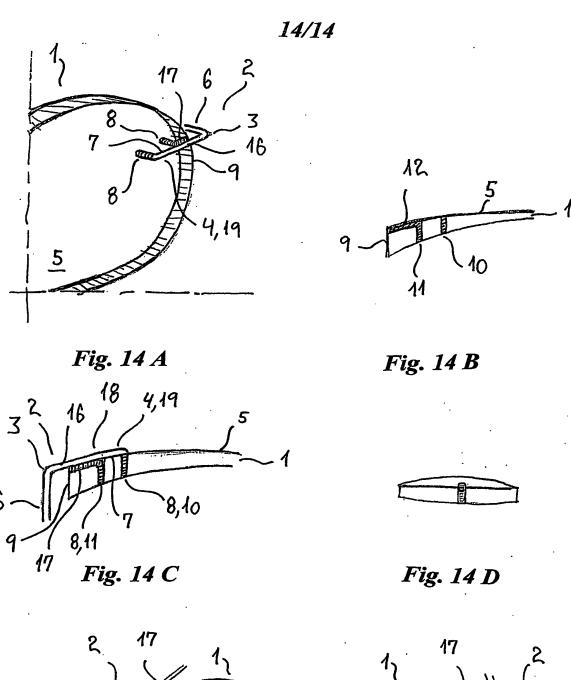


Fig. 13



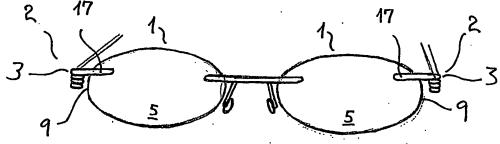


Fig. 14 E